881F Series High-Current Fast Opening SMD Fuse

Rohs 6 HF cWus

Single fuse solution for high

Suitable for a wide variety

of voltage requirement and

against overload and short

Compatible with high volume

assembly requirements

Enhanced product reliability

Conforms to IEC/EN 60127-1

current applications

Guaranteed protection

circuit current events

and performance

and IEC/EN 60127-7

application



Additional Information



Resources

Accessories

Agency Approvals

Samples

Description

This high-current SMD fuse is a small, square, surface mount fuse that is designed as supplemental overcurrent protection for highcurrent circuits in various applications. This faster opening version enhances protection of the product from overload and short circuit current events in the application.

Features & Benefits

- Available in 70A, 80A, and 100A ratings
- High interrupting rating -1500A @ 75Vdc
- With faster opening time response
- Surface mountable high current fuse
- Robust and solderless fuse design
- Lead-free, Halogen-free, and RoHS compliant
- UL Recognized to UL/CSA/NMX 248-1

Applications

- Blade Servers
- Routers
- High-power Battery Systems
- Power Factor Correction (PFC) in high wattage power supplies
- Power Distribution Units (PDUs)

Electrical Characteristics for Series

| Agency | Agency File Number | Ampere Range | % of Ampere Rating | Opening Time |
|-----------------|--------------------|--------------|--------------------|------------------|
| c RU °us | E71611 | 70A – 100A | 100% | 1 Hour, Min. |
| \triangle | J50501628 | 70A – 100A | 200% | 60 Seconds, Max. |

Electrical Specifications by Item

| Ampere | MaxW | Max Voltage | Voltage Interrupting | Interrupting Rating (mOhms) Nominal Voltag | Nominal Voltage | Nominal Melting ** I²t (A²sec) | Agency Approvals | |
|------------|----------|-------------|----------------------|-----------------------------------------------|-----------------|--------------------------------------|------------------|-------------|
| Rating (A) | Amp Code | Rating (V) | | | Drop * (mV) | | c W us | \triangle |
| 70 | 070. | | | 0.82 | 89 | 1050 | Х | Х |
| 80 | 080. | 75Vdc | 1500A @75Vdc | 0.63 | 86 | 2000 | Х | Х |
| 100 | 100. | | | 0.52 | 96 | 4800 | Х | Х |

* Nominal Voltage Drop measured at 100% rated Current. ** Nominal Melting I²t measured at 1500A.

Thermal Characteristics

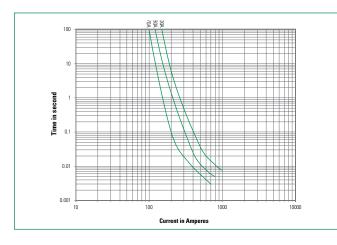
| Ampere Rating | Typical Case Temperature Rise (°C) * | | | |
|--------------------|--------------------------------------|---------------------|----------------------|--|
| I _n (A) | @ 50%I _n | @ 75%l _n | @ 100%l _n | |
| 70 | 16 | 38 | 73 | |
| 80 | 25 | 58 | 88 | |
| 100 | 32 | 60 | 127 | |

* Typical values based on tests conducted with fuse mounted on FR-4 circuit board of 0.062" (1.6 mm) thickness with 6 oz. (210 μm) Cu.

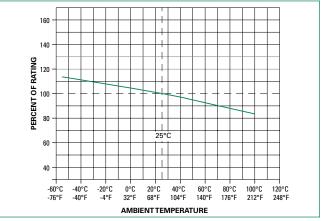


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Average Time Current Curves



Temperature Re-rating Curve



Note: 1. Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

For continuous operation at 70°C, the fuse should be re-rated as follows:

 $\begin{array}{l} \textbf{10} \quad \text{commonsoir} \quad \textbf{10} \quad \text{commonsoir} \quad \textbf{10} \quad$ rating curve, please consult Littelfuse technical support assistance.

| Reflow Condi | tion | Pb – Free assembly | | |
|---------------------------|--------------------------------------------------|-------------------------|--|--|
| Pre Heat | - Temperature Min (T _{s(min)}) | 150°C | | |
| | - Temperature Max (T _{s(max)}) | 200°C | | |
| | -Time (Min to Max) (t _s) | 60 – 180 secs | | |
| Average ramp | 5°C/second max. | | | |
| $T_{S(max)}$ to T_L - F | 5°C/second max. | | | |
| Reflow | - Temperature (T_L) (Liquidus) | 217°C | | |
| | - Temperature (t _L) | 60 – 150 seconds | | |
| Peak Tempera | ture (T _P) | 260+ ^{0/-5} °C | | |
| Time within 5 | 5°C of actual peak Temperature (t _p) | 20 – 40 seconds | | |
| Ramp-down I | Rate | 5°C/second max. | | |
| Time 25°C to | peak Temperature (T _P) | 8 minutes max. | | |
| Do not excee | d | 260°C | | |

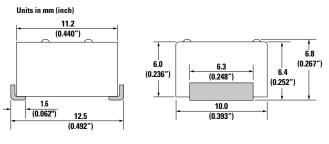
t_P ∣₄ -TP Critical Zone T_L to T_P Ramp-up Î \mathbf{T}_{L} $\mathbf{T}_{\mathrm{S(max)}}$ T_{S(max)} T_{S(min)} Ramp-down Preheat 25 time to peak temperature (t 25°C to peak) Time •

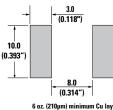
Soldering Parameters

Fuse Datasheet

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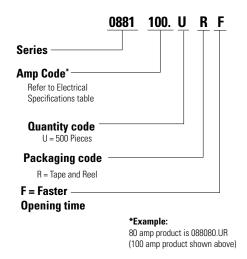
Dimensions





6 oz. (210µm) minimum Cu layer Recommended Pad Layout

Part Numbering System



Packaging

| Packaging Option | Packaging Specification | Quantity | Quantity & Packaging Code |
|--------------------|------------------------------|----------|------------------------------|
| 24mm Tape and Reel | EIA-481 Rev. D (IEC 60286-3) | 500 | UR |

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Product Characteristics

| Materials | Body: Thermoplastic, RTI 150°C Terminations: Tin-plated Copper |
|--------------------------------------|-----------------------------------------------------------------------------|
| Product Marking | Brand logo, Voltage Rating, 'F' (Faster Opening Time), and Ampere Rating |
| Operating Temperature ^{1 2} | -55° to +100°C with proper derating |
| Notes: | |

1. Based on loading at 75% of ampere rating when mounted using recommended pad layout. 2. Usage outside of stated operating temperature range requires testing in application

Maintain case temperature below 150°C in application.

| | MIL-Std 202 Method 107 | | |
|---------------------------|-------------------------------------|--|--|
| Thermal Shock | Test Condition B (-65°C to 125°C, 5 | | |
| | cycles). | | |
| | MIL-Std 202 method 106 | | |
| Moisture Resistance | High Humidity (90-98%RH), Heat | | |
| | (65°C) | | |
| Vibration | MIL-STD-202, Method 201 (10-55 Hz) | | |
| | MIL-STD-202, Method 213, | | |
| Mechanical Shock | Test Condition I | | |
| | (100 G's peak for 6 milliseconds) | | |
| Resistance to Solder Heat | MIL-Std 202 Method 210 | | |
| Resistance to Solder Heat | Test Condition B (10sec at 260°C) | | |
| Solderability | MIL-STD-202 Method 208 | | |
| MSL Test | Level 1 J-STD-020 | | |
| | MIL-Std 202 Method 101 | | |
| Salt Fog | Test Condition B (5% NaCL solution, | | |
| | 48 hours exposure) | | |

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